



Receipt  
#3

DOCUMENT NUMBER: 202887US2/mmb

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

IN RE APPLICATION OF:  
Yuuichi HIRANO, et al.

: GROUP: 2811

SERIAL NUMBER: 09/778,104

: ATTENTION:  
Application Division  
Customer Corrections

FILED: February 7, 2001

FOR: SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING SAME

**REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

It is respectfully requested that the filing date of the above-identified application be corrected to FEB 07 01. To substantiate the correct filing date of FEB 07 01, we attach a copy of the date-stamped filing receipt card. The filing receipt card has been stamped by the Patent Office when the application was presented at the Patent Office filing window in person by the Patent Office runner of this firm.

The Patent Office is requested to provide a corrected Official Filing Receipt indicating the correct filing date and any other requested corrections.

No fees are required. However, in the event that a fee is required, please charge the appropriate amount to our Deposit Account No. 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

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## UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS  
UNITED STATES PATENT AND TRADEMARK OFFICE  
WASHINGTON, D.C. 20231  
WWW.USPTO.GOV

APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
09/778,104	01/07/2001	2811	710	202887US2	22	13	3

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CONFIRMATION NO. 4460

## FILING RECEIPT



\*OC000000006105766\*

Date Mailed: 05/23/2001

Receipt is acknowledged of this nonprovisional Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Customer Service Center. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

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## Assignment For Published Patent Application

MITSUBISHI DENKI KABUSHIKI KAISHA, Tokyo, JAPAN;

## Domestic Priority data as claimed by applicant

## Foreign Applications

JAPAN P2000-236814 08/04/2000

If Required, Foreign Filing License Granted 05/22/2001

Projected Publication Date: 02/07/2002

Non-Publication Request: No

Early Publication Request: No

## Title

Semiconductor device and method of manufacturing same

## Preliminary Class

257

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MAY 25 2001

Data entry by : PRASASOUK, NOUSALY

Team : OIPE

Date: 05/23/2001

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75 76 77 78 79 80 81 82 83 84 85 86 87 88 89 90 91 92 93 94 95 96 97 98 99 100

PLEASE NOTE THAT THE FILING DATE IS INCORRECT. IT SHOULD READ AS  
FOLLOWS:FILING DATE: 02/07/2001



142

Dept.: PP/JF

By: MJS/scm

OSMM&N File No. 202887US2

Serial No. New Application

In the matter of the Application of: Yuuichi HIRANO, et al.

For: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING  
SAME

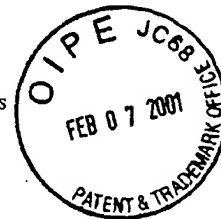
The following has been received in the U.S. Patent Office on the date stamped hereon:

- ☒ 34 pp. Specification & 13 Claims/Drawings 22 Sheets (Formals)
- ☒ Combined Declaration, Petition & Power of Attorney 4 pages
- ☐ List of Inventor Names and Addresses
- ☒ Utility Patent Application
- ☐ Notice of Priority
- ☒ Check for \$710.00
- ☒ Fee Transmittal Form
- ☐ Assignment/PTO 1595 pages:
- ☐ Letter to Official Draftsman
- ☐ Letter Requesting Approval of Drawing Changes
- ☐ Drawings sheets ☐ Formal
- ☐ Letter
- ☐ Amendment
- ☒ Information Disclosure Statement
- ☒ Cited References (3)
- ☐ Search Report
- ☐ Statement of Relevancy
- ☐ IDS/Related/List of Related Cases
- ☐ Restriction Response
- ☐ Rule 132 Declaration
- ☐ Petition for Extension of Time
- ☐ Notice of Appeal
- ☐ Brief
- ☐ Issue Fee Transmittal
- ☒ White Advance Serial Number Card
- ☐ Small Entity Status is Claimed
- ☐
- ☐

☐ CPA

☒ Priority Doc (1)

☒ Dep. Acct. Order Form



☒ PTO-1449

☐ Cited Pending Applications

☐ Election Response

Due Date: 08/04/01